ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES* Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
T52 21 1 IPC Web Site for Information on IPC-1752 Standard			Form Type Distribute					ials and Mfg Information						
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2024-04	2024-04-29			
Contact Name Title - Contact			et		Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product			duct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - R			- Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Iten		n Number Mfr Item Name			Effective Date	e Date Version Manufacturing Site			Weight*	UOM	Unit Type		
	NSVBC G	NSVBC114EDXV6T1 SS SOT563 RSTR G		R XSTR TR		2024-04-29 CI		CN1		2.72	mg	Each		
Manufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	terial	al Terminal Base Alloy		J-STD-020 MSI	L Rating	Peak Proce	Process Body Temperature Max Time at Peal		Tempera	ture Num	ber of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU All		CU Alloy	1			260 C		С	30 seco		seconds 3			
Comments														
level 1 - maximum time at peak temperatu	re during so	dering is 10-3	0 seconds											
For more information regarding material (composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury,										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.06	mg	Supplier	Silicon (Si)	7440-21-3		0.06	mg	
Lead Frame	1.18	mg	Supplier	Silver (Ag)	7440-22-4		0.21	mg	
			В	Nickel (Ni)	7440-02-0		0.3646	mg	
			Supplier	Iron (Fe)	7439-89-6		0.5039	mg	
			Supplier	Copper (Cu)	7440-50-8		0.1015	mg	
Mold Compound-Black	1.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.14	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.007	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.203	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.91	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.14	mg	
Plating	0.06	mg	Supplier	Tin (Sn)	7440-31-5		0.06	mg	
Wire Bond - Cu	0.02	mg	Supplier	Copper (Cu)	7440-50-8		0.02	mg	